Preferred Device

Triacs

Silicon Bidirectional Thyristors

Designed primarily for full-wave ac control applications, such as solid-state relays, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied main terminal voltage with positive or negative gate triggering.

- Blocking Voltage to 800 Volts
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Three Modes (MAC15 Series) or Four Modes (MAC15A Series)
- Device Marking: Logo, Device Type, e.g., MAC15A6, Date Code

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage ⁽¹⁾ (T _J = -40 to +125°C, Sine Wave 50 to 60 Hz, Gate Open) MAC15A6 MAC15-8, MAC15A8 MAC15-10, MAC15A10	VDRM, VRRM	400 600 800	Volts
Peak Gate Voltage (Pulse Width $\leq 1.0 \mu sec; T_C = 90^{\circ}C$)	V _{GM}	10	Volts
On–State Current RMS Full Cycle Sine Wave 50 to 60 Hz (T _C = +90°C)	I <mark>T(RMS)</mark>	15	A
Circuit Fusing Consideration (t = 8.3 ms)	l ² t	93	A ² s
Peak Non-repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _C = +80°C) Preceded and followed by rated current	ITSM	150	A
Peak Gate Power (T _C = +80°C, Pulse Width = 1.0 μs)	PGM	20	Watts
Average Gate Power (T _C = +80°C, t = 8.3 ms)	PG(AV)	0.5	Watts
Peak Gate Current (Pulse Width ≤ 1.0 μsec; T _C = 90°C)	IGM	2.0	А
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

(1) VDRM and VRRM for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the large ratings of the devices are exceeded.



ON Semiconductor

http://onsemi.com

TRIACS 15 AMPERES RMS 400 thru 800 VOLTS





TO-220AB CASE 221A STYLE 4

PIN ASSIGNMENT			
1	Main Terminal 1		
2	Main Terminal 2		
3	Gate		
4	Main Terminal 2		

ORDERING INFORMATION

Device	Package	Shipping
MAC15-8	TO220AB	500/Box
MAC15-10	TO220AB	500/Box
MAC15A6	TO220AB	500/Box
MAC15A8	TO220AB	500/Box
MAC15A10	TO220AB	500/Box

Preferred devices are recommended choices for future use and best overall value

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case — Junction to Ambient	R _θ JC R _θ JA	2.0 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	T_L	260	°C

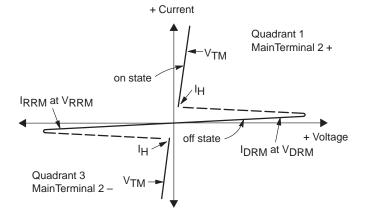
$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_C = 25^{\circ}\text{C unless otherwise noted}; \ \text{Electricals apply in both directions})$

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u>'</u>	•		•	
Peak Blocking Current $T_J = 25^{\circ}C$ (V _D = Rated V _{DRM} , V _{RRM} ; Gate Open) $T_J = 125^{\circ}C$	I _{DRM,} IRRM	_	_	10 2.0	μA mA
ON CHARACTERISTICS				•	
Peak On–State Voltage ⁽¹⁾ ($I_{TM} = \pm 21$ A Peak)	V _{TM}	_	1.3	1.6	Volts
Gate Trigger Current (Continuous dc) $ (V_D=12\ Vdc,\ R_L=100\ Ohms) $ $ MT2(+),\ G(+) $ $ MT2(+),\ G(-) $ $ MT2(-),\ G(-) $ $ MT2(-),\ G(+)\ "A"\ SUFFIX\ ONLY $	lGT	_ _ _ _	_ _ _ _	50 50 50 75	mA
Gate Trigger Voltage (Continuous dc) $(V_D=12\ Vdc,\ R_L=100\ Ohms)$ $MT2(+),\ G(+)$ $MT2(+),\ G(-)$ $MT2(-),\ G(-)$ $MT2(-),\ G(+)\ "A"\ SUFFIX\ ONLY$	VGT	_ _ _ _	0.9 0.9 1.1 1.4	2 2 2 2.5	Volts
Gate Non-Trigger Voltage (V _D = 12 V, R _L = 100 Ohms, T _J = 110°C) MT2(+), G(+); MT2(-), G(-); MT2(+), G(-) MT2(-), G(+) "A" SUFFIX ONLY	V _{GD}	0.2 0.2	_	_	Volts
Holding Current $(V_D = 12 \text{ Vdc}, \text{ Gate Open, Initiating Current} = \pm 200 \text{ mA})$	lн	_	6.0	40	mA
Turn-On Time $(V_D = Rated \ V_{DRM}, \ I_{TM} = 17 \ A)$ $(I_{GT} = 120 \ mA, \ Rise \ Time = 0.1 \ \mu s, \ Pulse \ Width = 2 \ \mu s)$	t _{gt}		1.5	_	μs
DYNAMIC CHARACTERISTICS					
Critical Rate of Rise of Commutation Voltage (V_D = Rated V_{DRM} , I_{TM} = 21 A, Commutating di/dt = 7.6 A/ms, Gate Unenergized, T_C = 80°C)	dv/dt(c)	_	5.0	_	V/µs

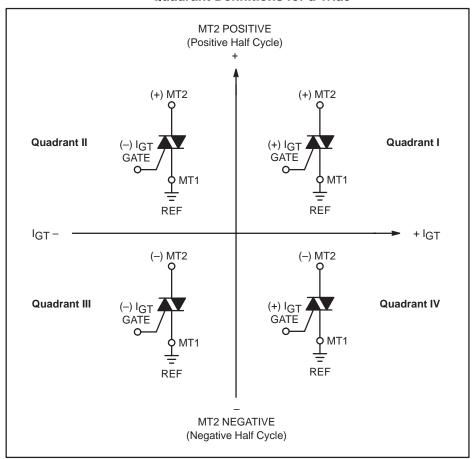
⁽¹⁾ Pulse Test: Pulse Width ≤ 2.0 ms, Duty Cycle ≤ 2%.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
VDRM	Peak Repetitive Forward Off State Voltage
IDRM	Peak Forward Blocking Current
VRRM	Peak Repetitive Reverse Off State Voltage
IRRM	Peak Reverse Blocking Current
VTM	Maximum On State Voltage
lΗ	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

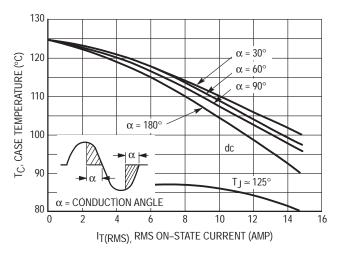


Figure 1. RMS Current Derating

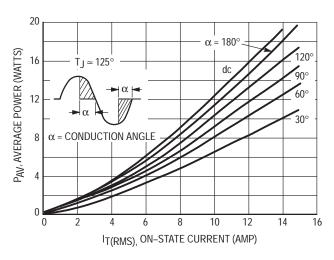


Figure 2. On-State Power Dissipation

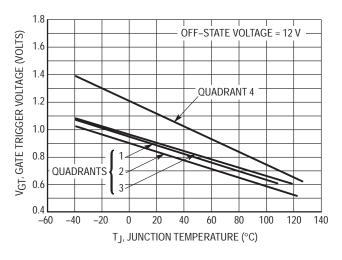


Figure 3. Typical Gate Trigger Voltage

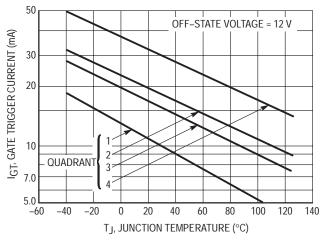


Figure 4. Typical Gate Trigger Current

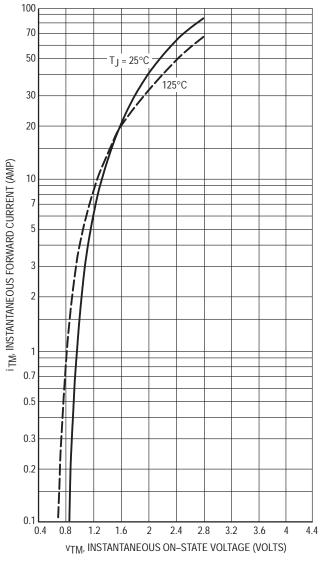


Figure 5. On-State Characteristics

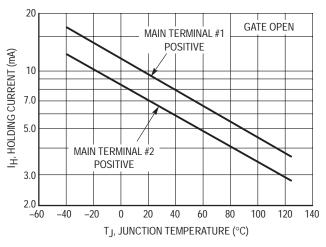


Figure 6. Typical Holding Current

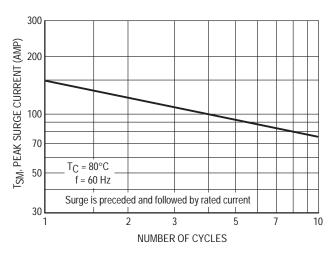


Figure 7. Maximum Non–Repetitive Surge Current

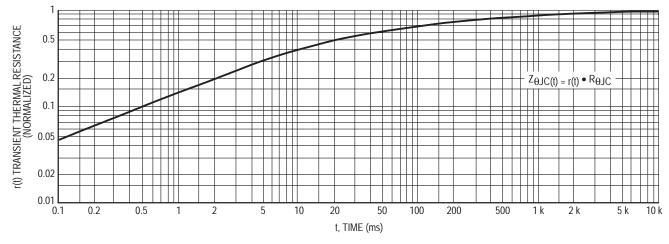
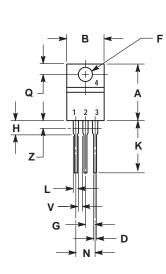
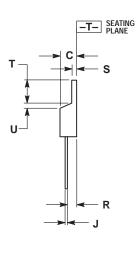


Figure 8. Thermal Response

PACKAGE DIMENSIONS

TO-220AB CASE 221A-07 ISSUE Z





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

- STYLE 4:
 PIN 1. MAIN TERMINAL 1
 2. MAIN TERMINAL 2
 3. GATE
 4. MAIN TERMINAL 2

Notes

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